

MULTI-INNO TECHNOLOGY CO., LTD.

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LCD MODULE SPECIFICATION

Model : MI1602A4

For Customer's Acceptance:

Customer		
Approved		
Comment		

Revision	1.0
Engineering	
Date	2012-03-04
Our Reference	



REVISION RECORD

REV NO.	REV DATE	CONTENTS	REMARKS
1.0	2012-03-04	First issued	



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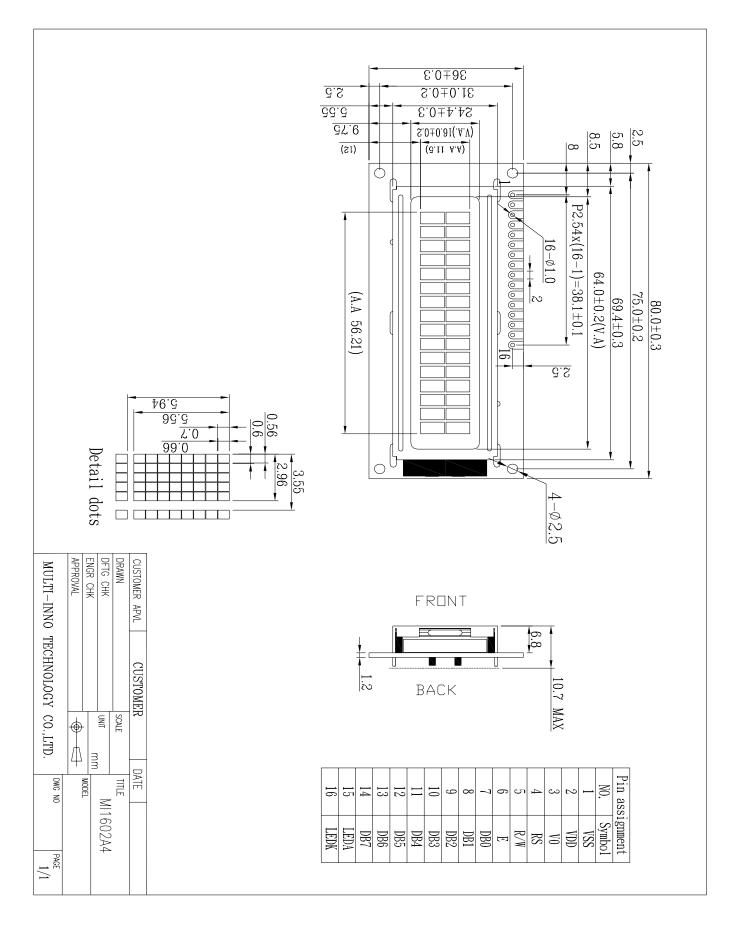


■ GENERAL INFORMATION

Item	Contents	Unit
LCD type	STN/Yellow-Green/Transflective/Positive	/
Viewing direction	6:00	O' Clock
Module area $(W \times H)$	$80.00 \times 36.00 \times 10.70$	mm ²
Viewing area (W×H)	64.00 × 16.00	mm ²
Active area (W×H)	56.21 × 11.50	mm ²
Number of characters	16 × 2	/
Character font	5×8Dots	/
Character size $(W \times H)$	2.96 × 5.56	mm ²
Character pitch $(W \times H)$	3.55 × 5.94	mm ²
Dot size $(W \times H)$	0.56 × 0.66	mm ²
Driver IC	AIP31066(English-japanese)	/
Backlight	LED/Yellow-Green	/
Interface Type	4/8 bit MPU	/
Driving method	1/16Duty,1/5Bias	/
Input voltage	5.0	V



EXTERNAL DIMENSIONS





■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage for logic	Vdd-Vss	-0.3	7.0	V
Supply voltage for LCD drive	VLCD	VDD-15.0	V _{DD} +0.3	V
Input voltage	Vin	-0.3	V _{DD} +0.3	V
Operating temperature	Тор	-20	70	°C
Storage temperature	Тѕт	-30	80	°C
Humidity	RH	-	90%(Max60°C)	RH

*. NOTE: The response time will be extremely slow when the operating temperature is around -10° C, and the back ground will become darker at high temperature operating.

■ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min	Тур	Max	Unit
Logic supply voltage	VDD-VSS	4.5	5.0	5.5	V
LCD drive	V _{LCD}	3.6	3.9	4.2	V
Input voltage ' H ' level	Vih	2.2	-	Vdd	V
Input voltage ' L ' level	VIL	-0.3	-	0.60	V
Frame frequency	F FLM	-	84.3	-	Hz
Current consumption	Idd	-	0.35	-	mA

DC CHARACTERISTICS

BACKLIGHT CHARACTERISTICS

ABSOLUTE MAXIMUM RATINGS

ltem	Symbol	Condition	min	Тур	Max	Unit
Forward Current	IF		-	-	140	mA
Reverse Voltage	VR	Ta = 25 °C	-	-	10	V
Power Dissipation	PD		-	-	1400	mW

ELECTRICAL-OPTICAL CHARACTERISTICS

Item	Symbol	Condition	min	Тур	Max	Unit
Forward Voltage	VF	15 d 40 - A	4.1	4.2	4.3	V
Average Luminous Intensity	lv	lf=140mA Ta = 25 ℃	-	-	-	cd/m ²
Peak emission wavelength	λΡ		571	572	573	nm

The brightness is measured without LCD panel

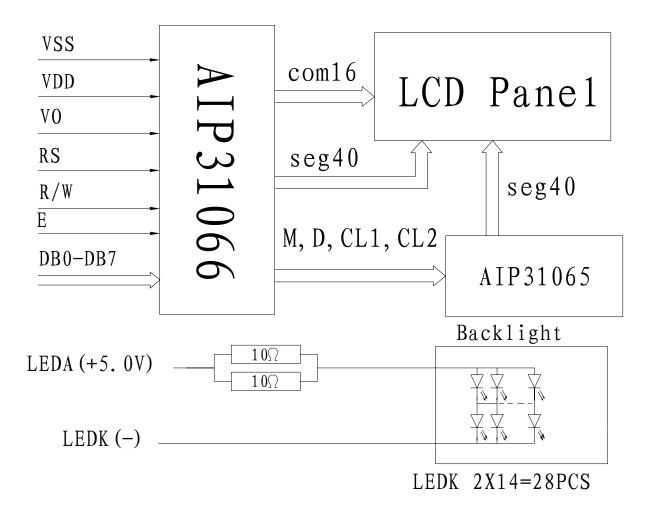


■ INTERFACE DESCRIPTION

1. INTERFACE PIN FUNCTION DESCRIPTION

PIN NO.	SYMBOL	FUNCIONS
1	VSS	Ground
2	VDD	Supply voltage for logical circuit
3	V0	Supply voltage for LCD driving
4	RS	A signal for selecting registers. 1: Data Register (for read and write) 0: Instruction Register (for write)
5	R/W	A signal for selecting read or write actions.1: Read, 0: Write.
6	Е	A enable signal for reading or writing data.
7-14	DB0~DB7	8 Bit Data Bus
15	LEDA	Backlight (+5.0V)
16	LEDK	Backlight (-)

2. BLOCK DIAGRAM





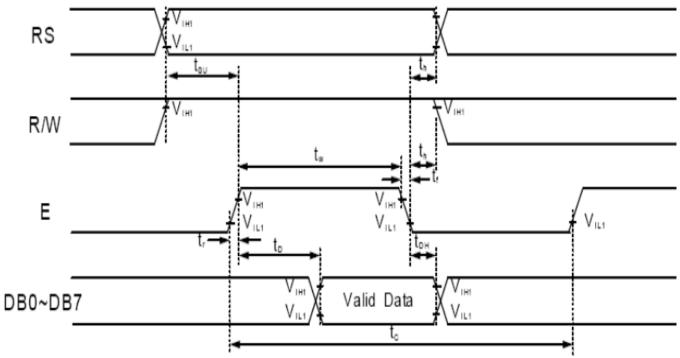
■ APPLICATION NOTES

1. TIMING CHARACTERISTICS

1-1 Read/Write mode

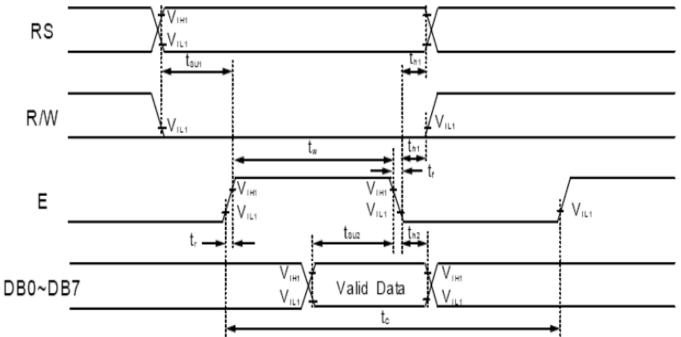
Mode	Characteristic	Symbol	Min.	Тур.	Max.	Unit	
	E Cycle Time	tc	500	23	-	(
	E Rise / Fall Time	t _R ,t _F	-	2	20		
	E Pulse Width (High, Low)	tw	230	-	-		
Write Mode (Refer to Fig-1)	R/W and RS Setup Time	t _{su1}	40	-	-	ns	
(resist to rig-r)	R/W and RS Hold Time	t _{en}	10	2	<u> </u>		
	Data Setup Time	t _{su2}	80	°.	-		
	Data Hold Time	t _{H2}	10	-			
	E Cycle Time	t _c	500	2	<u></u>		
	E Rise / Fall Time	t _R , t⊧	-	-	20		
903-11-00-00-00-00-00-00-00-00-00-00-00-00-	E Pulse Width (High, Low)	tw	230	0			
Read Mode (Refer to Fig. 2)	R/W and RS Setup Time	t _{su}	40	- 23	22	ns	
(Refer to Fig-2)	R/W and RS Hold Time	tн	10	13	-		
	Data Output Delay Time	to	-	-	120		
	Data Hold Time	t _{он}	5		2		

1-2 Read mode timing diagram

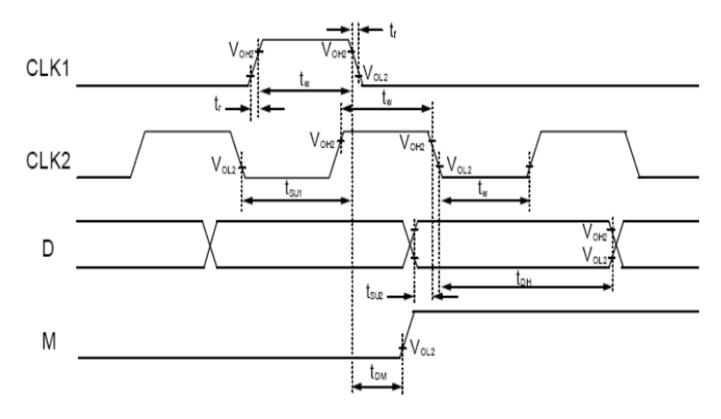




1-3 Write mode timing diagram



1-4 Interface mode





2. COMMAND LIST

Instruction				Inst	ructi	on C	ode				Description	Execution time (fosc=
instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	270 kHz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "20H" to DDRAM and set DDRAM address to '00H" from AC	1.53 ms
Return Home	0	0	0	0	0	0	0	0	1	-	Set DDRAM address to '00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53 ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	ѕн	Assign cursor moving direction and enable the shift of entire display.	39 µs
Display ON/ OFF Control	0	0	0	0	0	0	1	D	с	в	Set display(D), cursor(C), and blinking of cursor(B) on/off control bit.	39 µs
Cursor or Display Shift	0	0	0	0	0	1	s/c	R/L	-	-	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 µs
Function Set	0	0	0	0	1	DL	N	F	-	-	Set interface data length (DL: 8-bit/4-bit), numbers of display line (N: 2-line/1-line) and, display font type (F:5×11dots/5×8 dots)	39 µs
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39 µ5
Set DDRAM Address	0	O	1	AC6	AC5	AC4	AC3	AC2	AC1	ACO	Set DDRAM address in address counter.	39 µs
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 µs
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43 µs
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	DO	Read data from internal RAM (DDRAM/CGRAM).	43 µs

* "-": dont care

NOTE: When an MPU program with checking the Busy Flag(DB7) is made, it must be necessary 1/2Fosc is necessary for executing the next instruction by the falling edge of the 'E' signal after the Busy Flag (DB7) goes to "Low".



3.CHARACTER GENERATOR ROM

Upp # 4 Lever Bits 4 Bits	00 00	0001	0010	0011	0100	0101	0110	0111	1000	1001	1010	1011	11 00	1 101	11 10	1111
xxxx0000	CG RAM (1)			0	Ð	P	•	F					9	Ξ,	ĊĊ	p
xxxx0001	(2)			1	A	Q	a	9				7	Ŧ	4	â	q
xxxx0010	(3)			2	B	R	Ь	┢╍				1	Ņ	X	P	8
xxxx0011	(4)		#	3	C	S	C	5				7	Ŧ	E	3	60
xxxx0100	(5)		\$	4	D	T	d	₽.			••	I	ŀ.	╋┚	┢┛	ŝ
xxxx0101	(6)		7	5		U	e	U				7	,		6	Ü
xxxx0110	(7)		8	6	F	Ų	f	V			7	ħ			ρ	Σ
xxxx0111	(8)		7	7	G	ľ'ľ	9	W			7	ŧ	7	7	9	π
xxxx1000	(1)		ζ	8		Х	h	X			4	2	7	IJ	٦.	X
xxxx1001	(2))	9	Ι	Y	i	ч			Ċ	ካ	ļ	IĻ	-1	Ч
xxxx1010	(3)		ж,		J	Ζ	j	Z			I		Ŋ	Ŀ	j	Ŧ
xxxx1011	(4)		╋	;	K		k	ł			*	ţ	L		X	F
xxxx1100	(5)		7	<		¥	1				Þ	Ð	2	7	¢	Ħ
xxxx1101	(6)		-		М		M	}			1	Z	7		ŧ	÷
xxxx1110	(7)			>	Ν	Λ	n	÷			3	E	ф,	•	ħ	
xxxx1111	(8)		/	?	O		O	÷			ų	y	7	•	Ö	

Note: The user can specify any pattern for character-generator RAM.



■ RELIABILITY

No.	Test Item	Test Condition	Inspection after test	
1	High Temperature Storage	$80\pm2^{\circ}C/96$ hours		
2	Low Temperature Storage	$-30\pm2^{\circ}C/96$ hours	Inspection after	
3	High Temperature Operating	$70\pm2^{\circ}C/96$ hours	2~4hours storage	
4	Low Temperature Operating	$-20\pm2^{\circ}C/96$ hours	at room	
5	Temperature Cycle	-20±2℃~25~70±2℃×10cycles (30min.) (5min.) (30min.)	temperature, the sample shall be	
6	Damp Proof Test	$60^{\circ}\text{C} \pm 5^{\circ}\text{C} \times 90\%$ RH/96 hours	free from defects:	
7	Vibration Test	Frequency: 10Hz~55Hz~10Hz Amplitude: 1.5mm, X, Y, Z direction for total 3hours (Packing condition)	 Air bubble in the LCD; Sealleak; Non-display; missing segments; Glass crack; Current Idd is twice higher than initial 	
8	Dropping test	Drop to the ground from 1m height, one time, every side of carton. (Packing condition)		
9	ESD test	Voltage: ± 8 KV R: 330 Ω C: 150pF Air discharge, 10time	value.	

Remark:

1. The test samples should be applied to only one test item.

2.Sample size for each test item is 5~10pcs.

3.For Damp Proof Test, Pure water(Resistance>10M Ω) should be used.

4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judge as a good part.

Using ionizer(an antistatic blower) is recommended at working area in order to reduce electro-static voltage. When removing protection film from LCM panel, peel off the tag slowly(recommended more than one second) while blowing with ionizer toward the peeling face to minimize ESD which may damage electrical circuit.

5.EL evaluation should be excepted from reliability test with humidity and temperature: Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.

6.Please use automatic switch menu(or roll menu) testing mode when test operating mode.



■ INSPECTION CRITERIA

This specification is made to be used as the standard acceptance/rejection criteria for Normal LCM Product.

1 Sample plan

Sampling plan according to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, normal level 2 and based on:

Major defect: AQL 0.65

Minor defect: AQL 1.5

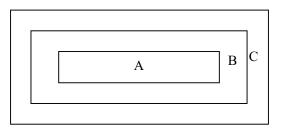
2. Inspection condition

•Viewing distance for cosmetic inspection is about 30cm with bare eyes, and under an environment of 20~40W light intensity, all directions for inspecting the sample should be within 45 $^{\circ}$ against perpendicular line. (Normal temperature 20~25°C and normal humidity 60±15%RH).

• Driving voltage

The Vop value from which the most optimal contrast can be obtained near the specified Vop in the specification (Within ± 0.5 V of the typical value at 25°C.).

3. Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer's product)

Fig.1 Inspection zones in an LCD.

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.



4.Inspection Standard 4.1 Major Defect

Item No	Items to be inspected	Inspection Standard	Classification of defects
4.1.1	All functional defects	 No display Display abnormally Missing vertical, horizontal segment Short circuit Back-light no lighting, flickering and abnormal lighting. 	
4.1.2	Missing	Missing component	Major
4.1.3	Outline dimension	Overall outline dimension beyond the drawing is not allowed.	

4. 2 Cosmetic Defect

4.2.1 Module Cosmetic Criteria

No.	Item	Judgement Criterion	Partition
1	Difference in Spec.	None allowed	Major
2	Pattern peeling	No substrate pattern peeling and floating	Major
3	Soldering defects	No soldering missing	Major
		No soldering bridge	Major
		No cold soldering	Minor
4	Resist flaw on Printed Circuit Boards	visible copper foil (\emptyset 0.5mm or more) on substrate pattern	Minor
5	Accretion of metallic	No accretion of metallic foreign matters (Not exceed $\emptyset 0.2$ mm)	Minor
	Foreign matter		Minor
6	Stain	No stain to spoil cosmetic badly	Minor
7	Plate discoloring	No plate fading, rusting and discoloring	Minor
8	Solder amount	a. Soldering side of PCB	Minor
	1. Lead parts	Solder to form a 'Filet' all around the lead. Solder should not hide the lead form perfectly. (too much) b. Components side (In case of 'Through Hole PCB')	
		Solder to reach the Components side of PCB.	
	2. Flat packages	Either 'Toe' (A) or 'Seal' (B) of the lead to be covered by 'Filet'.	Minor
	3. Chips	$(3/2) H \ge h \ge (1/2) H$	Minor
9	Solder ball/Solder splash	a. The spacing between solder ball and the conductor or solder pad $h \ge 0.13$ mn The diameter of solder ball d ≤ 0.15 mm. d	Minor
		 b. The quantity of solder balls or solder Splashes isn't beyond 5 in 600 mm². c. Solder balls/Solder splashes do not violate minimum electrical clearance. 	Minor Major



d. Solder balls/Solder splashes must be entrapped/encapsulated Or attached to the metal surface .	Minor
NOTE: Entrapped/encapsulated/attached is intended to mean that normal service environment of the product will not cause a solder ball to become dislodged.	

4.2.2Cosmetic Criteria (Non-Operating)

No.	Defect	Judgment Criterion		
1	Spots	In accordance with Screen Cosmetic Criteria (Operating) No.1.		Minor
2	Lines	In accordance with Screen Cos	smetic Criteria (Operating) No.2.	Minor
3	Bubbles in polarizer			
		Size : d mm	Acceptable Qty in active area	
		d ≤ 0.3	Disregard	
		$0.3 < d \le 1.0$	3	
		$1.0 < d \le 1.5$	1	
		1.5 < d	0	
4	Scratch	In accordance with spots and lines operating cosmetic criteria. When the		
		light reflects on the panel surface, the scratches are not to be remarkable.		
5	Allowable density	Above defects should be separated more than 30mm each other.		
6	Coloration	Not to be noticeable coloration in the viewing area of the LCD panels.		
		Back-lit type should be judged with back-lit on state only.		
7	Contamination	Not to be noticeable.		



4. 2. 3 Cosmetic Criteria (Operating)

No.	Defect	Judgment Criterion		
1	Spots	A) Clear		
		Lcd size Size : d mm Acceptable Qty in active area		
		$\frac{1}{d \leq 0.1} \qquad \frac{1}{Disregard}$		
		Lcd size $0.1 < d \le 0.2$ 6		
		8.0' $0.2 < d \le 0.3$ 2		
		0.3 < d 0		
		d ≤ 0.1 Disregard		
		Lcd size>8.0' $0.1 < d \le 0.3$ 10		
		0.3 <d≤0.5 5<="" td=""><td></td></d≤0.5>		
		0.5 < d 0		
		 Note : Including pin holes and defective dots which must be within one pixel size; Total defective point shall not exceed 6 pcs no more than 8 inch LCD and 10PCS for more than 8 inch LCD. B) Unclear 		
		Lcd size Size : d mm Acceptable Qty in active area		
		d≤0.2 Disregard		
		Lcd size $\langle 0.2 \rangle$ $\langle 0.2$		
		8.0' $0.5 < d \le 0.7$ 2		
		0.7 <d 0<="" td=""><td></td></d>		
		d≤0.2 Disregard		
		0.2 <d≤0.5 10<="" td=""><td></td></d≤0.5>		
		$Lcd size > 8.0' \qquad 0.5 < d \le 0.7 \qquad 3$		
		$0.7 \le d \le 1.0 \qquad 1$		
2	Lines	Note : Total defective point shall not exceed 6 pcs for no more than 8inch LCD and 10PCS for more than 8 inch LCD.A) Clear	3 Minor	
2	Lines		IVIIIIOI	
		L5.0 (0)		
		2.0 (6) See No. 1		
		W		
		0.02 0.05 0.1		
Note: () - Acceptable Qty in active area L - Length (mm) W - Width (mm) ∞ - Disregard B) Unclear				
		L10.0 (0)		
		2.0 (6)		
		W		
		0.05 0.3 0.5		
		 'Clear' = The shade and size are not changed by V_{op}. 'Unclear' = The shade and size are changed by V_{op}. 		



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3	Rubbing line	Not to be noticeable.	Minor
4	Allowable density	Above defects should be separated more than 10mm each other.	Minor
5	Rainbow	Not to be noticeable.	Minor
6	Dot size	To be 95% ~ 105% of the dot size (Typ.) in drawing. Partial defects of each dot (ex. pin-hole) should be treated as 'Spot'. (see <i>Screen Cosmetic Criteria (Operating) No.1</i>)	Minor
7	Uneven brightness (only back-lit type module)	Uneven brightness must be BMAX / BMIN ≤ 2 - BMAX : Max. value by measure in 5 points - BMIN : Min. value by measure in 5 points Divide active area into 4 vertically and horizontally. Measure 5 points shown in the following figure.	Minor
		0 0	
		0 0 0	
		O : Measuring points	

Note :

(1) Size : d = (long length + short length) / 2

(2) The limit samples for each item have priority.

(3) Complex defects are defined item by item, but if the numbers of defects are defined in above table, the total number should not exceed 10.

(4) In case of 'concentration', even the spots or the lines of 'disregarded' size should not allowed. Following three situations should be treated as 'concentration'.

- 7 or over defects in circle of \emptyset 5mm.

- 10 or over defects in circle of \emptyset 10mm.

- 20 or over defects in circle of \emptyset 20mm.



■PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

(1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.

(2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.

(3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).

(4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.

(5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents

- Isopropyl alcohol

- Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

(6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.

- Water

- Ketone

- Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

(7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

(8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

(9) Do not attempt to disassemble or process the LCD module.

(10) NC terminal should be open. Do not connect anything.

(11) If the logic circuit power is off, do not apply the input signals.

(12) Electro-Static Discharge Control, Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.

- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.

- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential

- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated

(13) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.

- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.

- Do not damage or modify the pattern writing on the printed circuit board.

- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.

- Do not drop, bend or twist LCM.



Handling precaution for LCM

LCM is easy to be damaged. Please note below and be careful for handling. Correct handling:





As above picture, please handle with anti-static gloves around LCM edges.

Incorrect handling:

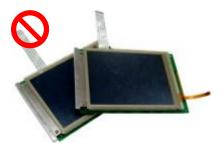




Please don't hold the surface of panel.



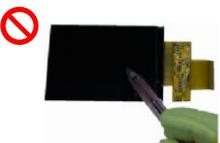
Please don't hold the surface of IC.



Please don't stack LCM.



Please don't stretch interface of output, such as FPC cable.



Please don't operate with sharp stick such as pens.



Storage Precautions

When storing the LCD modules, the following precaution is necessary.

(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.

(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.

(3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the anti-static electricity container in which they were shipped.

Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.

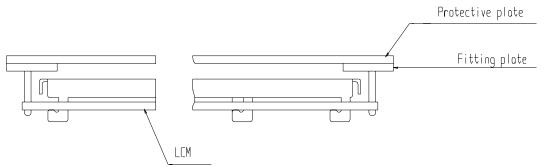
-Terminal electrode sections.

USING LCD MODULES

Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

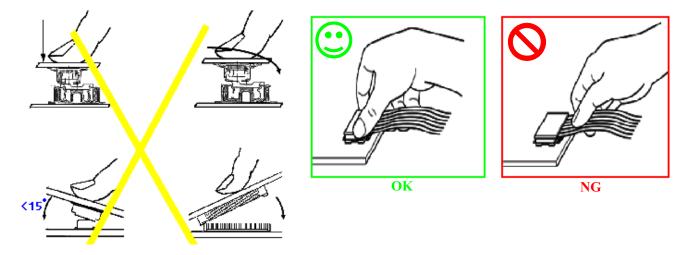
(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ± 0.1 mm.

Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position, don't assemble or assemble like the method which the following picture shows





Precaution for soldering the LCM

	Manual soldering	Machine drag soldering	Machine press soldering
No ROHS	290°C ~350°C.	330°C ~350°C.	300°C ~330°C.
product	Time : 3-5S.	Speed : 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa
ROHS	340°C ~370°C.	350°C ~370°C.	330°C ~360°C.
product	Time : 3-5S.	Time : 4-8 mm/s.	Time : 3-6S.
product			Press: 0.8~1.2Mpa

(1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

(2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

(3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

Precautions for Operation

(1) Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.

(2) It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

(3) Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, Which will come back in the specified operating temperature.

(4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.

(5) A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature, 50%RH or less is required.

(6) Input logic voltage before apply analog high voltage such as LCD driving voltage when power on. Remove analog high voltage before logic voltage when power off the module. Input each signal after the positive/negative voltage becomes stable.

(7) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

Safety

(1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

Limited Warranty

Unless agreed between Multi-Inno and customer, Multi-Inno will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with Multi-Inno LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned to Multi-Inno within 90 days of shipment. Confirmation of such date shall be based on data code on product. The warranty liability of Multi-Innolimited to repair and/or replacement on the terms set forth above. Multi-Innowill not be responsible for any subsequent or consequential events.

Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- PCB eyelet is damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- Soldering to or modifying the bezel in any manner.



Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

PRIOR CONSULT MATTER

- 1. (1) For Multi-Innostandard products, we keep the right to change material, process ... for improving the product property without notice on our customer.
- ⁽²⁾For OEM products, if any change needed which may affect the product property, we will consult with our customer in advance.
- 2.If you have special requirement about reliability condition, please let us know before you start the test on our samples.